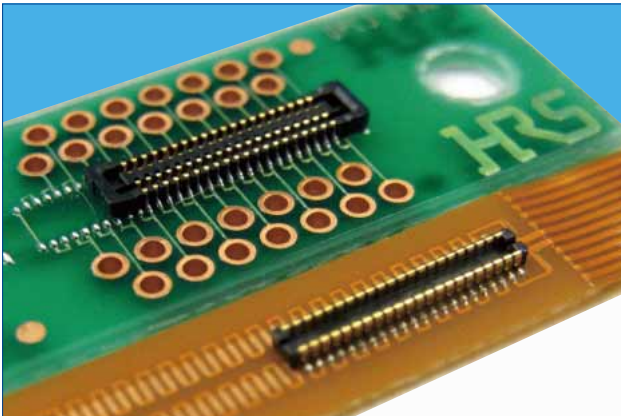


0.4mm Pitch, 0.6 and 0.8mm Height, Board-to-Board and Board-to-FPC Connectors

BM20 Series



■Features

1. High density mounting capability

A space saving design that keeps the connector compact, but still maintains an adequate vacuum area (no less than 0.7mm wide).

Depth DS : 2.3mm DP : 1.78mm

2. Reliable contact performance

Even though the mated height is low, the BM20 still leads it class in maximum effective mating lengths for each mating height.

<Effective Mating Length>

Height 0.8mm : 0.2mm

Height 0.6mm : 0.15mm

The addition of the two point contact system adds more reliability to the contacts.

3. No restrictions to PCB pattern design for the 0.8 mm height connector *1

This series utilizes a thin wall to insulate the bottom surface of the connector and maintains an effective mating length of 0.2mm. This removes any restriction for PCB pattern layout design under the connector.

Note *1: There are some restrictions for the 0.6 mm height style.

4. Enhanced mating operations

The structure uses guide ribs to ease the mating process and offers a self alignment range of up to 0.3mm. A clear tactile click is used as an indicator to the user that the mating process was completed.

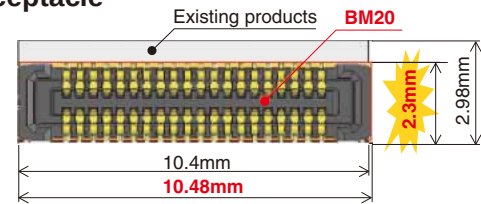
5. Drop and shock resistant structure

Dimples were designed into the contacts to increase their retention force and to absorb the shock delivered from a drop or other impact.

6. Debris resisting design

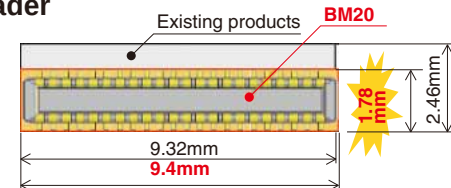
When mated, the connector's design covers the contacts which help to keep dust and other debris away from the contacts. The SMT leads are kept very close to the connector housing which also helps to prevent shorts caused by debris on the exposed contacts

■Receptacle



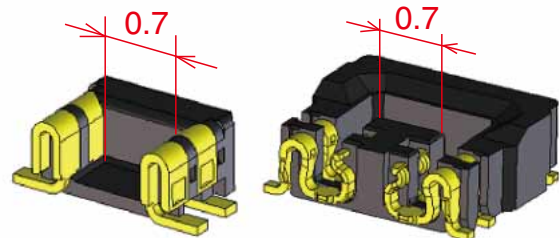
Existing products	BM20
2.98×10.4 = About 31.0mm ²	2.3×10.48 = About 24.1mm ²

■Header



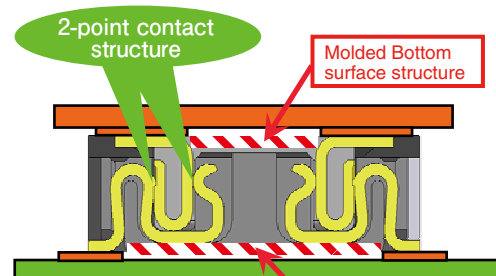
Existing products	BM20
2.46×9.32 = About 22.9mm ²	1.78×9.4 = About 16.7mm ²

Vacuum pick-up

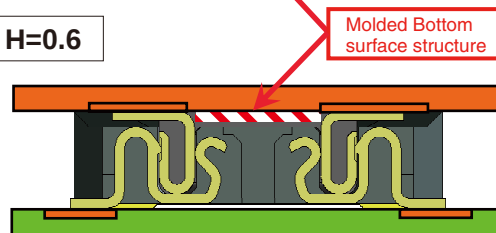


Mating diagram (cross section)

H=0.8



H=0.6



Product Specifications

Ratings	Rated Current	0.3A	Operating Temperature Range	- 35 ~ 85°C (Note 1)	Storage Temperature Range	- 10 ~ 60°C (Note 2)
	Rated Voltage	AC, DC 30V	Operating Humidity Range	20 ~ 80%	Storage Humidity Range	40 ~ 70% (Note 2)

Items	Specifications	Conditions
1. Insulation Resistance	Minimum of 50MΩ	Measured with DC 100V
2. Withstanding Voltage	No flashover or breakdown	Apply AC 100V for 1 minute
3. Contact Resistance	Maximum of 100mΩ	Measured with AC 20 mV, 1 kHz and 1 mA
4. Vibration Resistance	No electrical discontinuity of 1μs or greater	Frequency 10-55 Hz, half amplitude 0.75mm, 3 directions for 2 hours
5. Humidity Resistance	Contact resistance Maximum of 100mΩ Insulation resistance Minimum of 25mΩ	Left at temperature 40±2°C, humidity 90 to 95%, 96 hours
6. Temperature Cycles	Contact resistance Maximum of 100mΩ Insulation resistance Minimum of 50mΩ	(-55°C : 30 minutes → 5~35°C : 10 minutes → 85°C : 30 minutes → 5~35°C : 10 minutes) 5 cycles
7. Durability	Contact Resistance: maximum of 100mΩ	10 mating cycles
8. Soldering Heat Resistance	Should be no melting of resin parts that affects its performance	Reflow : according to the Recommended Solder Profile Hand solder : Soldering iron temperature 350°C, no more than 3 seconds.

Note 1 : Includes temperature rise caused by current flow.

Note 2 : The term "storage" here refers to products stored for a long period prior to board mounting and use. The operating temperature and humidity range covers the non-energized condition of connectors after board mounting and the temporary storage conditions during transportation, etc.

Materials

Product	Component	Materials	Finish	UL Regulation
Receptacle	Insulator	LCP	Black	UL94V-0
Header	Contact	Phosphorous bronze	Gold plating	—————

Product Number Structure

Refer to this page when determining product specifications by model types. Please place orders with part numbers listed in this catalog. The characteristics and specifications of the product described in this catalog are reference values. Please make sure to check the latest delivery specifications at the time of product use.

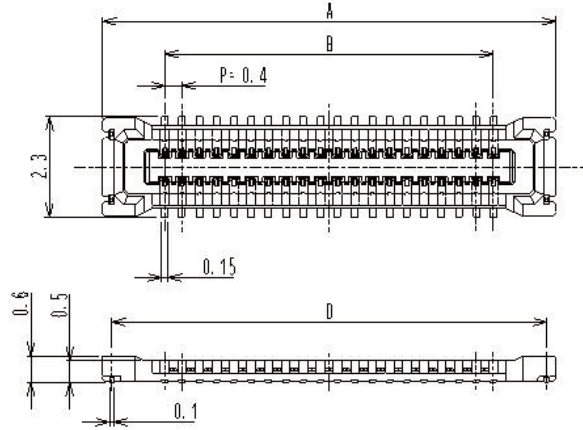
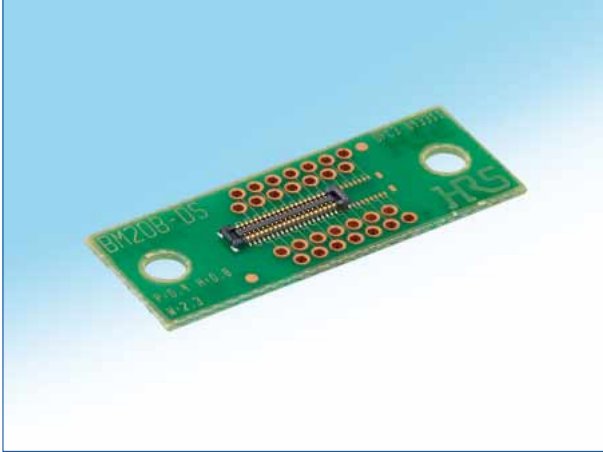
●Receptacle/Header

BM 20 # (**) - * DS - 0.4 V (51)

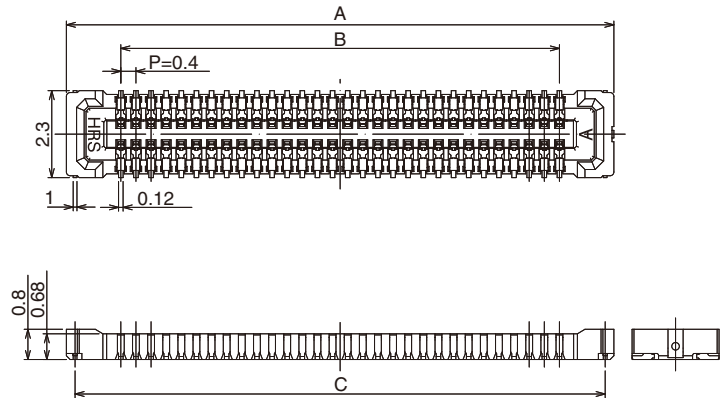
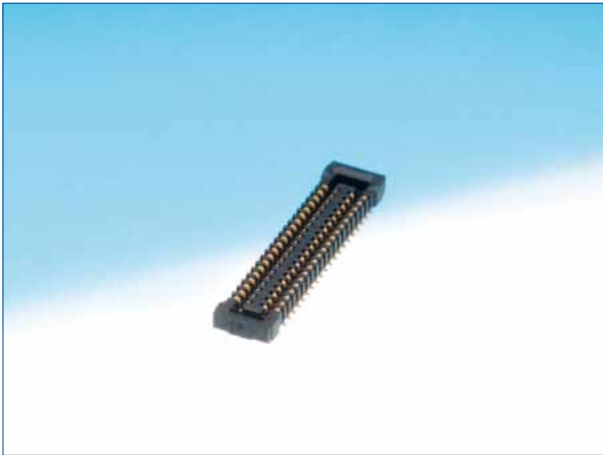
① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨

① Series Name : BM	⑥ Connector Type DS : Double row receptacle DP : Double row header
② Series No. : 20	
③ Shape Symbols B : With reinforcing metal fitting	⑦ Contact Pitch : 0.4mm
④ Stack height : 0.6mm, 0.8mm	⑧ Terminal Shape V : Vertical SMT
⑤ No. of Contacts : Please refer to page 3 and after.	⑨ Packaging (51) : Embossed tape package (8,000 pieces per reel)

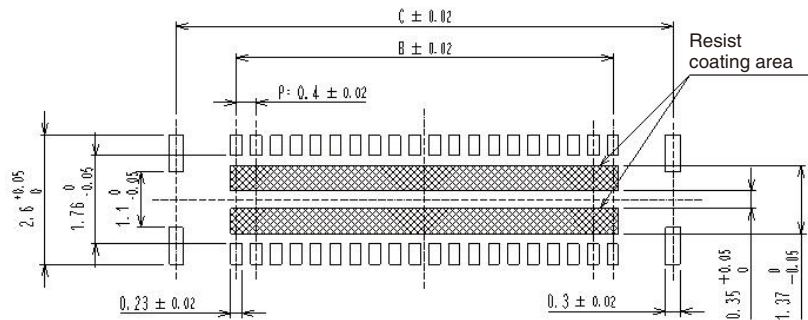
H=0.6mm receptacle



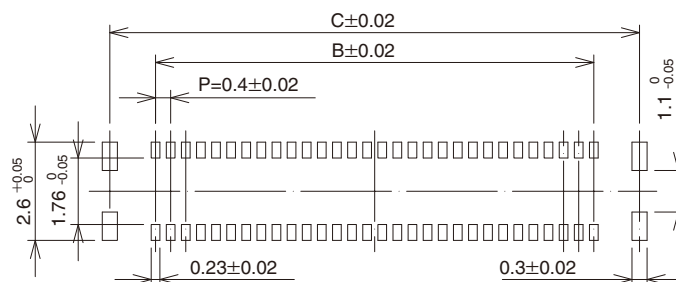
H=0.8mm receptacle



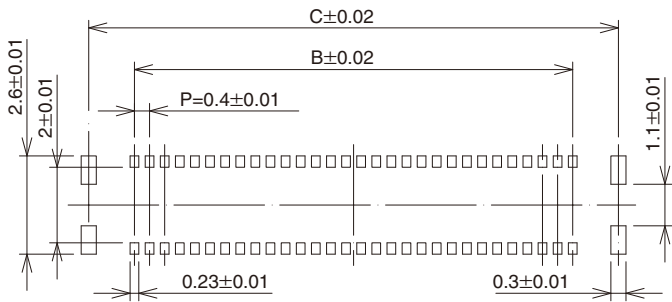
Recommended PCB layout [H= 0.6mm]



Recommended PCB layout [H= 0.8mm]



◆Recommended metal mask size (Mask thickness 100 μm) [0.6 mm and 0.8 mm common]



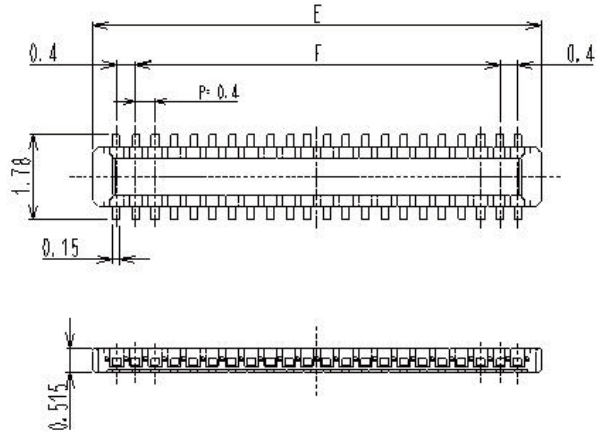
Unit : mm

Part No.	HRS No.	No. of Contacts	A	B	C	D
BM20B(0.6)-10DS-0.4V(51)	0684-9308-8 51	10	4.48	1.6	4.02	4.06
BM20B(0.6)-20DS-0.4V(51)	0684-9309-0 51	20	6.48	3.6	6.02	6.06
BM20B(0.6)-24DS-0.4V(51)	0684-9310-0 51	24	7.28	4.4	6.82	6.86
BM20B(0.6)-30DS-0.4V(51)	0684-9311-2 51	30	8.48	5.6	8.02	8.06
BM20B(0.6)-34DS-0.4V(51)	0684-9312-5 51	34	9.28	6.4	8.82	8.86
BM20B(0.6)-40DS-0.4V(51)	0684-9313-8 51	40	10.48	7.6	10.02	10.06
BM20B(0.6)-50DS-0.4V(51)	0684-9314-0 51	50	12.48	9.6	12.02	12.06
BM20B(0.6)-60DS-0.4V(51)	0684-9315-3 51	60	14.48	11.6	14.02	14.06

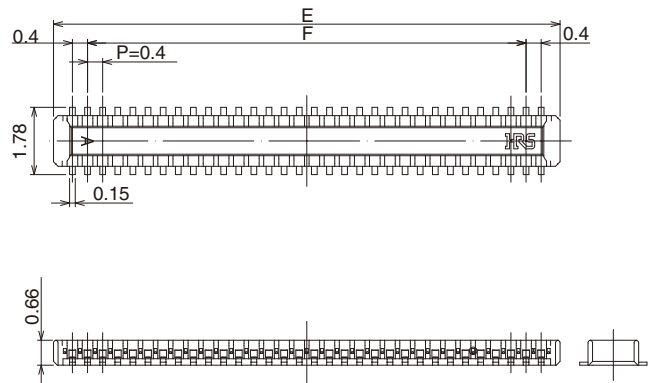
Part No.	HRS No.	No. of Contacts	A	B	C
BM20B(0.8)-10DS-0.4V(51)	0684-9008-4 51	10	4.48	1.6	4.02
BM20B(0.8)-16DS-0.4V(51)	0684-9041-0 51	16	5.68	2.8	5.22
BM20B(0.8)-20DS-0.4V(51)	0684-9009-7 51	20	6.48	3.6	6.02
BM20B(0.8)-24DS-0.4V(51)	0684-9010-6 51	24	7.28	4.4	6.82
BM20B(0.8)-30DS-0.4V(51)	0684-9011-9 51	30	8.48	5.6	8.02
BM20B(0.8)-34DS-0.4V(51)	0684-9020-0 51	34	9.28	6.4	8.82
BM20B(0.8)-40DS-0.4V(51)	0684-9012-1 51	40	10.48	7.6	10.02
BM20B(0.8)-50DS-0.4V(51)	0684-9013-4 51	50	12.48	9.6	12.02

Note 1 : This product is sold by full reel quantities of 8,000 pieces per reel. Please place orders in full reel quantities.
Note 2 : This connector is NOT polarized.

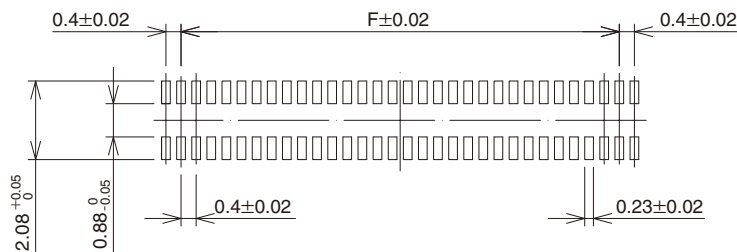
H=0.6mm header



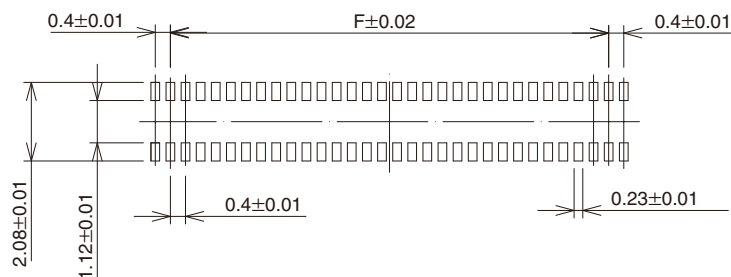
H=0.8mm header



Recommended PCB layout [0.6mm and 0.8mm common]



Recommended metal mask size (Mask thickness 100μm) [0.6mm and 0.8mm common]



Unit : mm

Part No	HRS No.	No. of Contacts	E	F
BM20B(0.6)-10DP-0.4V(51)	0684-9300-6 51	10	3.4	1.6
BM20B(0.6)-20DP-0.4V(51)	0684-9301-9 51	20	5.4	3.6
BM20B(0.6)-24DP-0.4V(51)	0684-9302-1 51	24	6.2	4.4
BM20B(0.6)-30DP-0.4V(51)	0684-9303-4 51	30	7.4	5.6
BM20B(0.6)-34DP-0.4V(51)	0684-9304-7 51	34	8.2	6.4
BM20B(0.6)-40DP-0.4V(51)	0684-9305-0 51	40	9.4	7.6
BM20B(0.6)-50DP-0.4V(51)	0684-9306-2 51	50	11.4	9.6
BM20B(0.6)-60DP-0.4V(51)	0684-9307-5 51	60	13.4	11.6

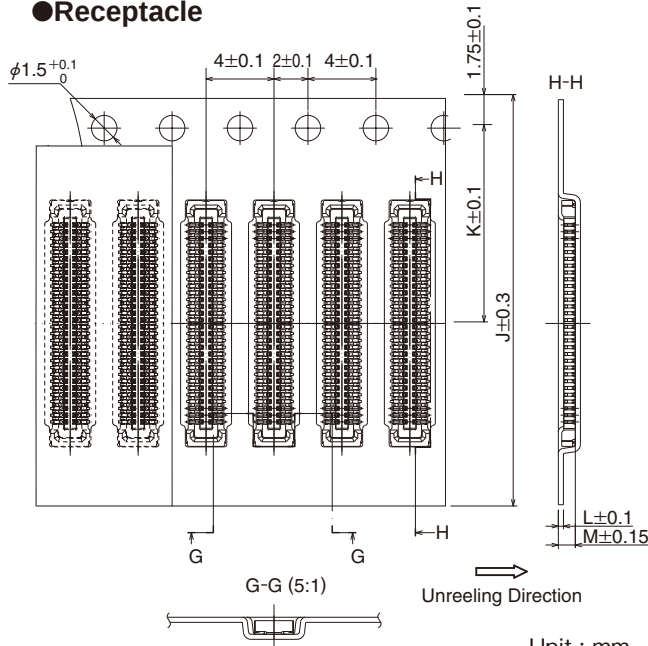
Part No	HRS No.	No. of Contacts	E	F
BM20B(0.8)-10DP-0.4V(51)	0684-9001-5 51	10	3.4	1.6
BM20B(0.8)-16DP-0.4V(51)	0684-9040-7 51	16	4.6	2.8
BM20B(0.8)-20DP-0.4V(51)	0684-9002-8 51	20	5.4	3.6
BM20B(0.8)-24DP-0.4V(51)	0684-9003-0 51	24	6.2	4.4
BM20B(0.8)-30DP-0.4V(51)	0684-9004-3 51	30	7.4	5.6
BM20B(0.8)-34DP-0.4V(51)	0684-9019-0 51	34	8.2	6.4
BM20B(0.8)-40DP-0.4V(51)	0684-9005-6 51	40	9.4	7.6
BM20B(0.8)-50DP-0.4V(51)	0684-9006-9 51	50	11.4	9.6

Note 1 : This product is sold by full reel quantities of 8,000 pieces per reel. Please place orders in full reel quantities.
Note 2 : This connector is NOT polarized.

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◆ Embossed Carrier Tape Dimensions (JIS C 0806 compliant)

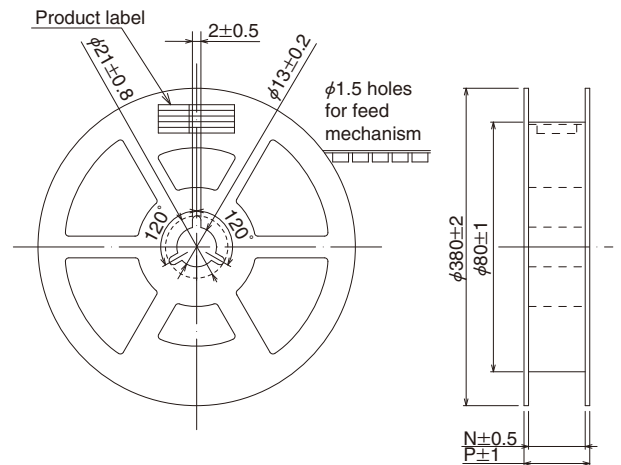
● Receptacle



Unit : mm

Part No.	J	K	L	M	N	P
BM20B(0.6)-10DS-0.4V(51)	16	7.5	0.25	0.8	17.5	21.5
BM20B(0.6)-20DS-0.4V(51)	16	7.5	0.25	0.8	17.5	21.5
BM20B(0.6)-24DS-0.4V(51)	16	7.5	0.25	0.8	17.5	21.5
BM20B(0.6)-30DS-0.4V(51)	24	11.5	0.25	0.8	25.5	29.5
BM20B(0.6)-34DS-0.4V(51)	24	11.5	0.25	0.8	25.5	29.5
BM20B(0.6)-40DS-0.4V(51)	24	11.5	0.25	0.8	25.5	29.5
BM20B(0.6)-50DS-0.4V(51)	24	11.5	0.25	0.8	25.5	29.5
BM20B(0.6)-60DS-0.4V(51)	24	11.5	0.25	0.8	25.5	29.5

● Reel Condition Dimensions

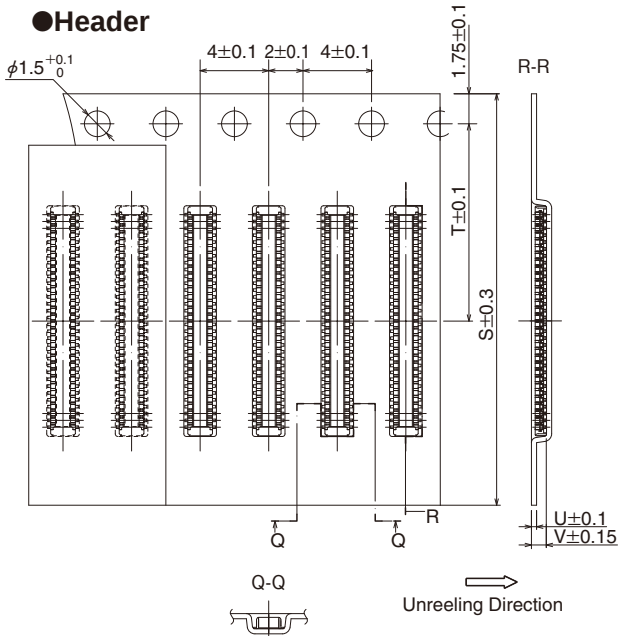


Unit : mm

Part No.	J	K	L	M	N	P
BM20B(0.8)-10DS-0.4V(51)	16	7.5	0.3	1	17.5	21.5
BM20B(0.8)-16DS-0.4V(51)	16	7.5	0.3	1	17.5	21.5
BM20B(0.8)-20DS-0.4V(51)	16	7.5	0.3	1	17.5	21.5
BM20B(0.8)-24DS-0.4V(51)	16	7.5	0.3	1	17.5	21.5
BM20B(0.8)-30DS-0.4V(51)	24	11.5	0.3	1	25.5	29.5
BM20B(0.8)-34DS-0.4V(51)	24	11.5	0.3	1	25.5	29.5
BM20B(0.8)-40DS-0.4V(51)	24	11.5	0.3	1	25.5	29.5
BM20B(0.8)-50DS-0.4V(51)	24	11.5	0.3	1	25.5	29.5

◆ Embossed Carrier Tape Dimensions (JIS C 0806 compliant)

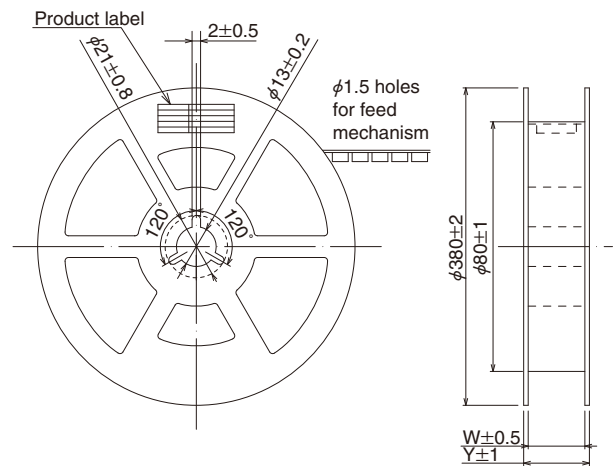
● Header



Unit : mm

Part No.	S	T	U	V	W	Y
BM20B(0.6)-10DP-0.4V(51)	12	5.5	0.25	0.65	13.5	17.5
BM20B(0.6)-20DP-0.4V(51)	16	7.5	0.25	0.65	17.5	21.5
BM20B(0.6)-24DP-0.4V(51)	16	7.5	0.25	0.65	17.5	21.5
BM20B(0.6)-30DP-0.4V(51)	16	7.5	0.25	0.65	17.5	21.5
BM20B(0.6)-34DP-0.4V(51)	24	11.5	0.25	0.65	25.5	29.5
BM20B(0.6)-40DP-0.4V(51)	24	11.5	0.25	0.65	25.5	29.5
BM20B(0.6)-50DP-0.4V(51)	24	11.5	0.25	0.65	25.5	29.5
BM20B(0.6)-60DP-0.4V(51)	24	11.5	0.25	0.65	25.5	29.5

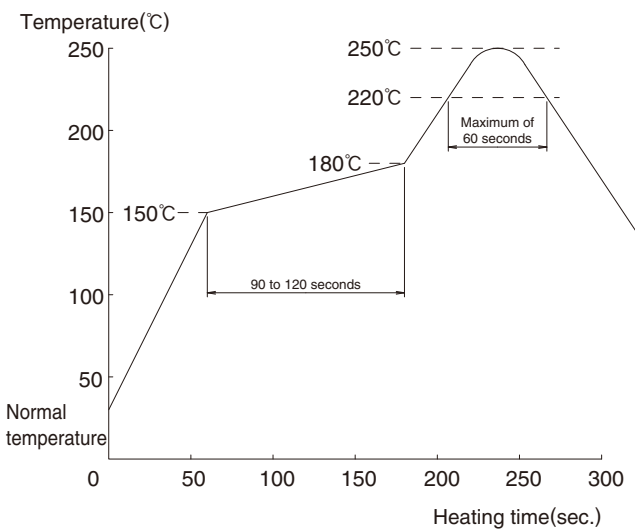
● Reel Dimensions



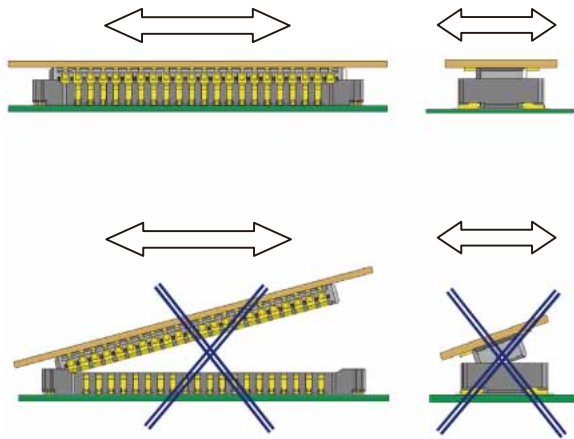
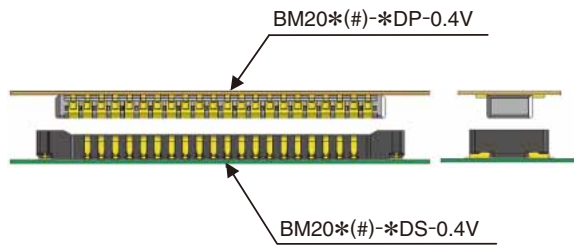
Unit : mm

Part No.	S	T	U	V	W	Y
BM20B(0.8)-10DP-0.4V(51)	12	5.5	0.3	0.88	13.5	17.5
BM20B(0.8)-16DP-0.4V(51)	16	7.5	0.3	0.88	17.5	21.5
BM20B(0.8)-20DP-0.4V(51)	16	7.5	0.3	0.88	17.5	21.5
BM20B(0.8)-24DP-0.4V(51)	16	7.5	0.3	0.88	17.5	21.5
BM20B(0.8)-30DP-0.4V(51)	16	7.5	0.3	0.88	17.5	21.5
BM20B(0.8)-34DP-0.4V(51)	16	7.5	0.3	0.88	17.5	21.5
BM20B(0.8)-40DP-0.4V(51)	24	11.5	0.3	0.88	25.5	29.5
BM20B(0.8)-50DP-0.4V(51)	24	11.5	0.3	0.88	25.5	29.5

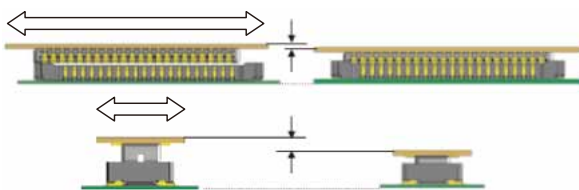
Operating Precautions

1. Recommended Solder Profile	 The graph shows the recommended solder profile with Temperature (°C) on the y-axis (0 to 250) and Heating time (sec.) on the x-axis (0 to 300). The profile starts at 'Normal temperature' (approx. 25°C), rises to 150°C (90 to 120 seconds), then to 180°C, and finally to a peak of 250°C (Maximum of 60 seconds) before cooling down. [Applicable Conditions] 1. Peak temperature : 250°C peak 2. Heating parts : 220°C or above, within 60 seconds 3. Preheating parts : 150 to 180°C, 90 to 120 seconds 4. Number of times : Maximum of 2 reflow cycles (Note 1) The temperatures mentioned above refer to the PCB surface temperature near the connector leads. (Note 2) When using nitrogen reflow please implement 1,000 [ppm] or higher oxygen density. Please contact the sales representative of our company in case of less than 1,000 [ppm].
2. Recommended hand solder conditions	The temperature of the soldering iron should fall within the range of $340 \pm 10^{\circ}\text{C}$ and should not make contact for longer than 3 seconds
3. Recommended screen thickness: Opening ratio (pattern area ratio)	Thickness : 0.1mm Opening ratio: DS side 70% DP side 80%(H=0.8mm) DP side 70%(H=0.6mm)
4. Leaning of PCB	Maximum of 0.02mm at the center of connector (using both edges of connector as criteria)
5. Washing	Cleaning is not recommended for this connector. Cleaning agents can deteriorate the mechanical operation and the environmental resistance of this connector.
6. Precautions	■ Do not mate or unmate these connectors until they are mounted, failure to follow this precaution can lead to deformation or damage to these connectors. ■ Provide another form of support to the PCB, this connector was not designed to be the main form of support. ■ Using excessive force to mate or unmate this connector can damage the contacts. ■ Do not apply excessive amounts of flux as it may cause the solder and flux to wick. ■ There may be a slight variance in the color of the molding between production lots, this variance will not affect the performance of the connector. ■ Refer to the next page for the handling precautions when mating and unmating the connectors. ■ If the connector becomes disconnected due to impact, a fall or a counterforce to the FPC, it may be necessary to hold the connector in place with an addition to the device's case or other cushioning material to hold the connector in place.

● Handling precautions when mating

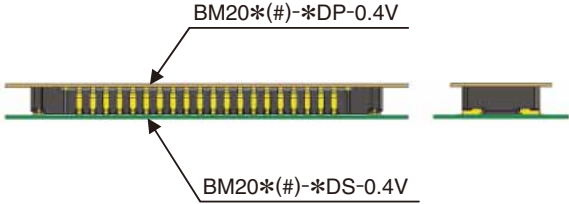
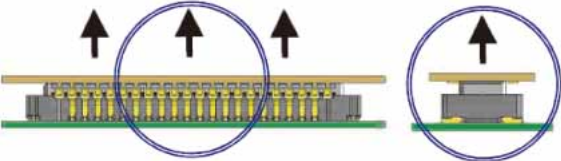
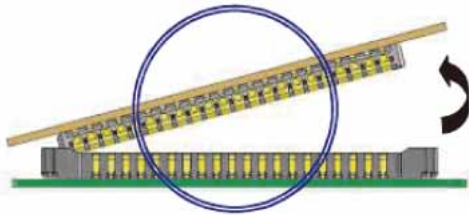
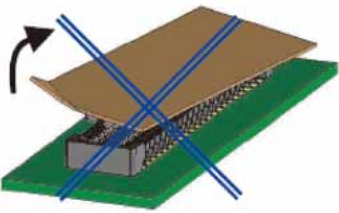
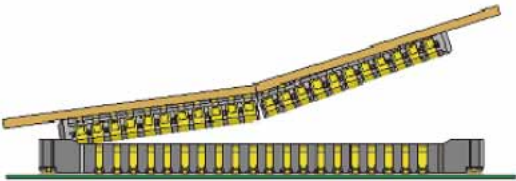


Prior to mating, locate the guidance ribs and align the header. Do not apply excessive force during the mating process as it may damage the contacts.



Make sure that the connector is parallel to the other side, then press it down until it is fully mated while maintaining the angle.

●Handling precautions for unmating

	
	To unmate this connector, lift evenly across the header. Make sure that each side of the connector stays parallel to the other.
 Pitch direction	If circumstances prevent the connectors from staying parallel to each other, then one side may be lifted as shown in the diagram. This method is only approved if the connector is mounted onto an extremely rigid circuit board. If the board were to warp during this process it may result in damage to the connector or its solder joints.
 Corner direction	Do not try to disconnect these connectors by pulling on one side or a single corner, or to unmate it when it hasn't been securely mounted onto a rigid FPC. These actions may lead to deformities and ultimately a damaged connector. Prior to the mounting of these connectors we recommend that you check the rigidity of your FPC to ensure that it meets the standards needed to support these connectors.
	If the FPC is not strong enough by itself, a stiffening backing may be applied. If the FPC has a low rigidity the connector may break (as shown in the illustration to the left). We recommend a backing of no less than 0.3mm of glass epoxy and 0.2mm of stainless material.

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MEMO :

Handwriting practice area consisting of 30 horizontal dashed lines.

This image shows a full page of a worksheet designed for handwriting practice. It consists of numerous horizontal dashed lines spaced evenly across the page, providing a guide for letter height and placement. The background is plain white, and there are no other markings or text present.

2-6-3, Nakagawa Chuoh, Tsuzuki-Ku, Yokohama-Shi 224-8540, JAPAN
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